

## DM7426

### Quad 2-Input NAND Gates with High Voltage Open-Collector Outputs

#### General Description

This device contains four independent gates each of which performs the logic NAND function. The open-collector outputs require external pull-up resistors for proper logical operation.

#### Pull-Up Resistor Equations

$$R_{MAX} = \frac{V_O (Min) - V_{OH}}{N_1 (I_{OH}) + N_2 (I_{IH})}$$

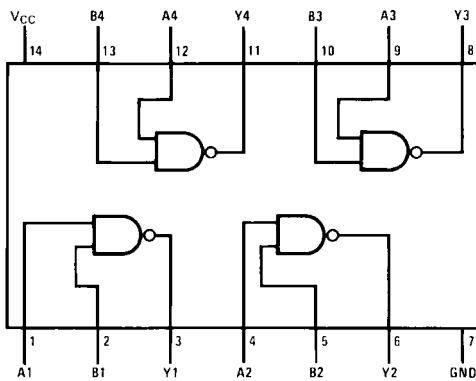
$$R_{MIN} = \frac{V_O (Max) - V_{OL}}{I_{OL} - N_3 (I_{IL})}$$

Where:  $N_1 (I_{OH})$  = total maximum output high current for all outputs tied to pull-up resistor  
 $N_2 (I_{IH})$  = total maximum input high current for all inputs tied to pull-up resistor  
 $N_3 (I_{IL})$  = total maximum input low current for all inputs tied to pull-up resistor

#### Ordering Code:

Order Number	Package Number	Package Description
DM7426N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

#### Connection Diagram



#### Function Table

$$Y = \overline{AB}$$

Inputs		Output
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

H = HIGH Logic Level  
L = LOW Logic Level

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**Absolute Maximum Ratings**(Note 1)

Supply Voltage	7V
Input Voltage	5.5V
Output Voltage	15V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	-65°C to +150°C

**Note 1:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Recommended Operating Conditions**

Symbol	Parameter	Min	Nom	Max	Units
V <sub>CC</sub>	Supply Voltage	4.75	5	5.25	V
V <sub>IH</sub>	HIGH Level Input Voltage	2			V
V <sub>IL</sub>	LOW Level Input Voltage			0.8	V
V <sub>OH</sub>	HIGH Level Output Voltage			15	V
I <sub>OL</sub>	LOW Level Output Current			16	mA
T <sub>A</sub>	Free Air Operating Temperature	0		70	°C

**Electrical Characteristics**

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V <sub>I</sub>	Input Clamp Voltage	V <sub>CC</sub> = Min, I <sub>I</sub> = -12 mA			-1.5	V
I <sub>CEX</sub>	HIGH Level Output Current	V <sub>CC</sub> = Min			1000	μA
		V <sub>IL</sub> = Max			50	
V <sub>OL</sub>	LOW Level Output Voltage	V <sub>CC</sub> = Min, I <sub>OL</sub> = Max			0.4	V
		V <sub>IH</sub> = Min				
I <sub>I</sub>	Input Current @ Max Input Voltage	V <sub>CC</sub> = Max, V <sub>I</sub> = 5.5V			1	mA
I <sub>IH</sub>	High Level Input Current	V <sub>CC</sub> = Max, V <sub>I</sub> = 2.4V			40	μA
I <sub>IL</sub>	Low Level Input Current	V <sub>CC</sub> = Max, V <sub>I</sub> = 0.4V			-1.6	mA
I <sub>CCH</sub>	Supply Current with Outputs HIGH	V <sub>CC</sub> = Max		4	8	mA
I <sub>CCL</sub>	Supply Current with Outputs LOW	V <sub>CC</sub> = Max		12	22	mA

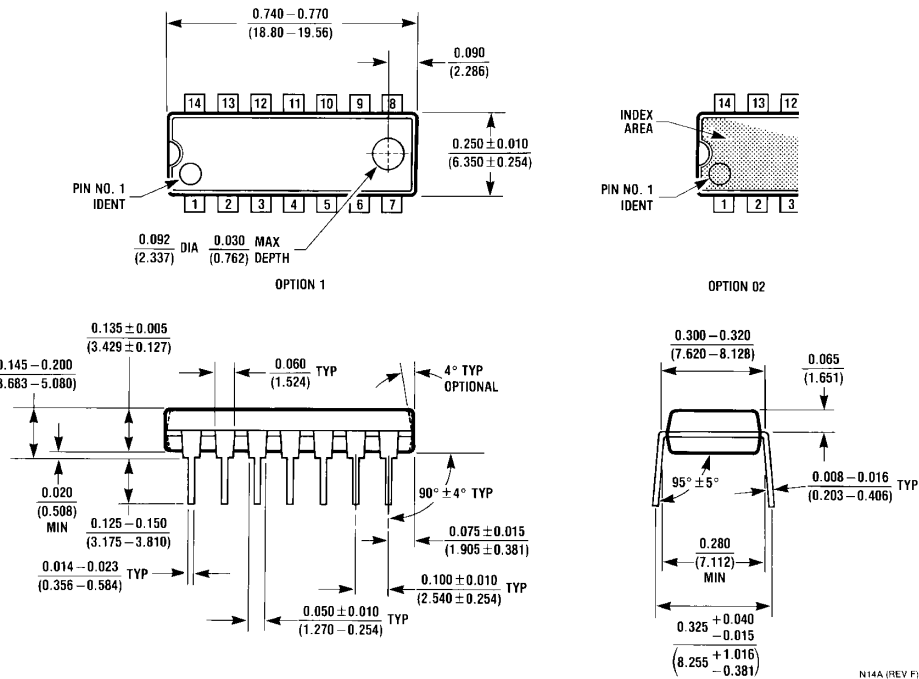
**Note 2:** All typicals are at V<sub>CC</sub> = 5V, T<sub>A</sub> = 25°C.

**Switching Characteristics**

at V<sub>CC</sub> = 5V and T<sub>A</sub> = 25°C

Symbol	Parameter	Conditions	Min	Max	Units
t <sub>PLH</sub>	Propagation Delay Time	C <sub>L</sub> = 15 pF R <sub>L</sub> = 1 kΩ (t <sub>PLH</sub> )		24	ns
	LOW-to-HIGH Level Output				
t <sub>PHL</sub>	Propagation Delay Time			17	ns
	HIGH-to-LOW Level Output				

**Physical Dimensions** inches (millimeters) unless otherwise noted



**14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A**

N14A (REV F)

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